

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

MIKAMI et al.

Art Unit: Unassigned

Application No. Unassigned

Examiner: Unassigned

Filed: December 11, 2003

For: AN UNDERLAYER FILM-FORMING
MATERIAL FOR COPPER, METHOD
FOR A FORMING UNDERLAYER FILM
FOR COPPER, AN UNDERLAYER FILM
FOR COPPER, AND A
SEMICONDUCTOR DEVICE

PRELIMINARY AMENDMENT

Mail Stop Patent Application
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

Prior to the examination of the above-identified patent application, please enter the following amendments and consider the following remarks.